

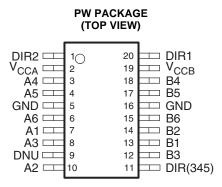
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SCES706A-SEPTEMBER 2008-REVISED MARCH 2009

## AUDIO CODEC AC'97 VOLTAGE-TRANSLATION TRANSCEIVER

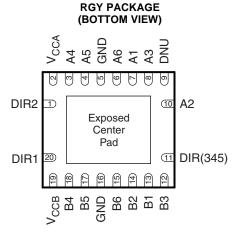
### **FEATURES**

- Voltage-Level Transceiver for Interfacing 1.8 V Audio Codec (AC'97) Controllers With 3.3 V AC'97 Codec Links
- Configurable I/O Switching Levels With Dual-Supply Pins Operating Over Full 1.2-V to 3.6-V Power-Supply Range
- For Low-Power Operation, A and B Ports Are Placed in High-Impedance State When Either Supply Voltage Is Switched Off



•	Latch-Up	Performance Exceeds 100 mA Per
	JESD 78,	Class II

- ESD Protection Exceeds JESD 22
  - 7000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1500-V Charged-Device Model (C101)



The exposed center pad, if used, must be connected as a secondary ground or left electrically open.

#### TERMINAL ASSIGNMENTS (20-Ball ZXY Package)

	Α	В	С	D
5	V <sub>CCA</sub>	DIR2	DIR1	V <sub>CCB</sub>
4	A5	A4	B4	B5
3	A6	GND	GND	B6
2	A3	A1	B2	B1
1	DNU <sup>(1)</sup>	A2	DIR(345)	B3

(1) DNU – Do not use; should be left unconnected

## **DESCRIPTION/ORDERING INFORMATION**

**ZXY PACKAGE** 

(TOP VIEW)

ABCD

0000

5

4

3

2

1

The SN74AVC6T622 is a voltage-level transceiver for interfacing 1.8 V audio codec (AC'97) controllers, the audio/analog modem functionality found in personal computers, with 3.3V AC'97 codec links. With the digital switching levels of today's AC'97 codecs lowering to 1.8-V logic levels, the SN74AVC6T622 device can be used to bridge the gap between legacy 3.3-V AC'97 codecs and AC'97 controllers that are now operating at 1.8 V. The 6-bit wide SN74AVC6T622 device complies with the AC'97 electrical interface (both levels and timing) specification.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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Two supply-voltage pins allow the A-port and B-port input switching thresholds to be configured separately. The A port is designed to track  $V_{CCA}$ , while the B port is designed to track  $V_{CCB}$ .  $V_{CCA}$  and  $V_{CCB}$  can accept any supply voltage from 1.2 V to 3.6 V.

If either  $V_{CC}$  is switched off ( $V_{CCA} = 0$  V and/or  $V_{CCB} = 0$  V), all outputs are placed in the high-impedance state to conserve power.

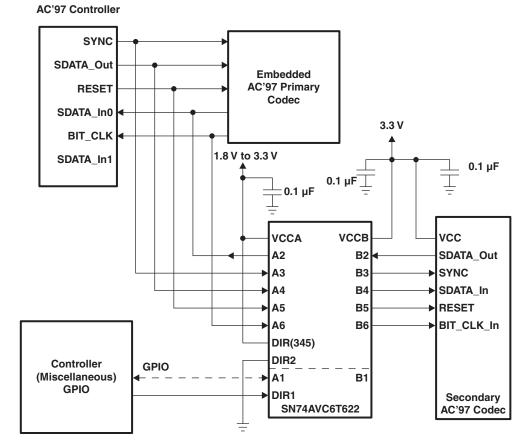
The SN74AVC6T622 is available in two 0.5-mm-pitch ball grid array (BGA) packages. The 20-ball package has dimensions of 3 mm × 2.5 mm, and the 24-ball package measures 3 mm × 3 mm. Memory cards are widely used in mobile phones, PDAs, digital cameras, personal media players, camcorders, set-top boxes, etc. Low static power consumption and small package size make the SN74AVC6T622 an ideal choice for these applications.

#### **ORDERING INFORMATION**

T <sub>A</sub>	PACKAGE <sup>(1)(2)</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING
	QFN – RGY	Reel of 1000	SN74AVC6T622RGYR	WU622
–40°C to 85°C	TSSOP – PW	Reel of 2000	SN74AVC6T622PWR	WU622
	UFBGA – ZXY (Pb-Free)	Reel of 2500	SN74AVC6T622ZXYR	WU622

(1) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.

(2) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.



#### REFERENCE DESIGN

Figure 1. Interfacing 1.8 V AC'97 Controllers With 3.3 V AC'97 Controllers

## SN74AVC6T622



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#### **TERMINAL FUNCTIONS**

ZXY BALL NO.	RGY, PW PIN NO.	NAME	TYPE	DESCRIPTION
A1	9	DNU		Do not use; leave unconnected
A2	8	A3	I	AC'97 controller SYNC signal
A3	6	A6	I	AC'97 controller BIT_CLK signal
A4	4	A5	I	AC'97 controller RESET signal
A5	2	V <sub>CCA</sub>	Pwr	A-port supply voltage. V <sub>CCA</sub> powers all A-port I/Os and control pins.
B1	10	A2	0	AC'97 controller SDATA_In0 signal
B2	7	A1	I/O	GPIO to miscellaneous GPIO controller
B3, C3	5, 16	GND	-	Ground
B4	3	A4	I	AC'97 controller SDATA_Out signal
B5	1	DIR2	-	Should be tied to GND
C1	11	DIR(345)	-	Should be tied to V <sub>CCA</sub>
C2	14	B2	I	Secondary AC'97 codec SDATA_Out signal
C4	18	B4	0	Secondary AC'97 codec SDATA_In signal
C5	20	DIR1	I	Direction control from miscellaneous GPIO controller
D1	12	B3	0	Secondary AC'97 codec SYNC signal
D2	13	B1	0	Optional GPIO signal if A1 is enabled
D3	15	B6	0	Secondary AC'97 codec BIT_CLK_In signal
D4	17	B5	0	Secondary AC'97 codec RESET signal
D5	19	V <sub>CCB</sub>	Pwr	B-port supply voltage. V <sub>CCB</sub> powers all B-port I/Os and control pins.

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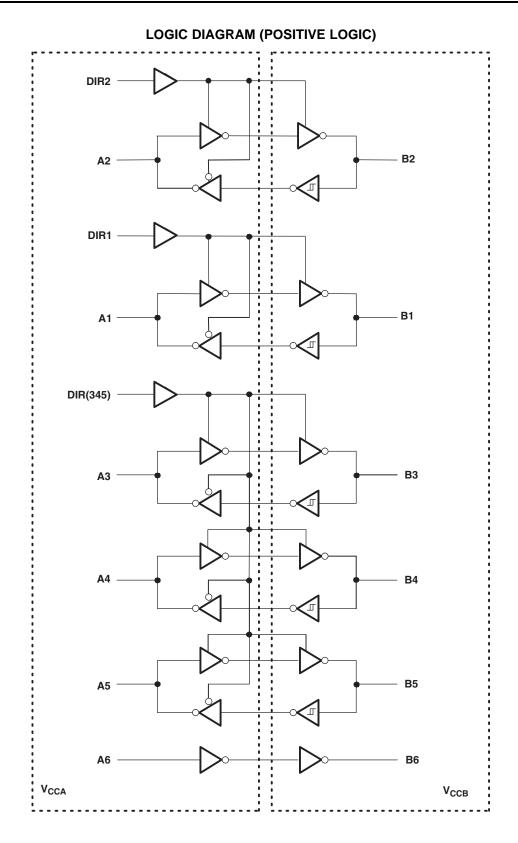
CONTROL INPUT	OUTPUT	OPERATION					
DIR2	A2	B2	OPERATION				
High	Hi-Z	Enabled	A2 to B2				
Low	Enabled	Hi-Z	B2 to A2				

CONTROL INPUT	OUTPUT	FUNCTION	
DIR1	A1	B1	FUNCTION
High	Hi-Z	Enabled	A1 to B1
Low	Enabled	Hi-Z	B1 to A1

CONTROL INPUT	OUTPUT	FUNCTION	
DIR(345)	A3, A4, A5	B3, B4, B5	FUNCTION
	Hi-Z		A3 to B3
High		Enabled	A4 to B4
			A5 to B5
			B3 to A3
Low	Enabled	Hi-Z	B4 to A4
			B5 to A5



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### ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
$V_{CCA}$ $V_{CCB}$	Supply voltage range		-0.5	4.6	V
		I/O ports (A port)	-0.5	4.6	
VI	Supply voltage range         Input voltage range applied to any output in the high-impedance or power-off state <sup>(2)</sup> Voltage range applied to any output in the high or low state <sup>(2)(3)</sup> Input clamp current         Output clamp current         Continuous output current         Continuous current through V <sub>CCA</sub> , V <sub>CCB</sub> , or GND	I/O ports (B port)	-0.5	4.6	V
		Control inputs	-0.5	4.6	
V	Voltage range applied to any output	A port	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	V	
Vo	in the high-impedance or power-off state <sup>(2)</sup>	B port	-0.5	4.6	v
V	Voltage range applied to any output in the high or law state $\binom{2}{3}$	A port	-0.5	V <sub>CCA</sub> + 0.5	V
Vo	Voltage range applied to any output in the high or low state $^{(2)(3)}$	B port	-0.5	V <sub>CCB</sub> + 0.5	v
I <sub>IK</sub>	Input clamp current	V <sub>1</sub> < 0		-50	mA
I <sub>OK</sub>	Output clamp current	V <sub>O</sub> < 0		-50	mA
I <sub>O</sub>	Continuous output current			±50	mA
	Continuous current through V <sub>CCA</sub> , V <sub>CCB</sub> , or GND			±100	mA
		PW package <sup>(4)</sup>		83	
$\theta_{JA}$	Package thermal impedance	RGY package <sup>(5)</sup>		37	°C/W
		ZXY package <sup>(4)</sup>		193	
T <sub>stg</sub>	Storage temperature range		-65	150	°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The input voltage and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

(2)

(3) The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current rating is observed.

The package thermal impedance is calculated in accordance with JESD 51-7. (4)

(5) The package thermal impedance is calculated in accordance with JESD 51-5.

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## SN74AVC6T622

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## **RECOMMENDED OPERATING CONDITIONS**<sup>(1)(2)(3)</sup>

			V <sub>CCI</sub>	V <sub>cco</sub>	MIN	MAX	UNIT
V <sub>CCA</sub>	Supply voltage				1.2	3.6	V
V <sub>CCB</sub>	Supply voltage				1.2	3.6	V
	High-level input voltage		1.2 V to 1.95 V		$V_{CCI} \times 0.65$		
V <sub>IH</sub>		All inputs <sup>(4)</sup>	1.95 V to 2.7 V		1.7		V
			2.7 V to 3.6 V		2		
			1.2 V to 1.95 V			V <sub>CCI</sub> × 0.35	
VIL	Low-level input voltage	All inputs <sup>(4)</sup>	1.95 V to 2.7 V			0.7	V
			2.7 V to 3.6 V			0.8	
VI	Input voltage	Control inputs			0	3.6	V
		Active state			0	V <sub>cco</sub>	
V <sub>I/O</sub>	Input/output voltage	3-state		-	0	3.6	V
				1.2 V		-1	
	High-level output current (A port)			1.4 V to 1.6 V		-1	
l <sub>он</sub>				1.65 V to 1.95 V		-2	mA
				2.3 V to 2.7 V		-4	
				3 V to 3.6 V		-8	
				1.2 V		1	
				1.4 V to 1.6 V		1	
I <sub>OL</sub>	Low-level output current (	A port)		1.65 V to 1.95 V		2	mA
				2.3 V to 2.7 V		4	
				3 V to 3.6 V		8	
				1.2 V		-1	
				1.4 V to 1.6 V		-2	
I <sub>OH</sub>	High-level output current	(B port)		1.65 V to 1.95 V		-4	mA
				2.3 V to 2.7 V		-8	
				3 V to 3.6 V		-16	
				1.2 V		1	
				1.4 V to 1.6 V		2	
l <sub>OL</sub>	Low-level output current (	B port)		1.65 V to 1.95 V		4	mA
				2.3 V to 2.7 V		8	
				3 V to 3.6 V		16	
Δt/Δv	Input transition rise or fall	rate				5	ns/V
T <sub>A</sub>	Operating free-air temper	ature			-40	85	°C

V<sub>CCI</sub> is the V<sub>CC</sub> associated with the input port.
 V<sub>CCO</sub> is the V<sub>CC</sub> associated with the output port.
 All unused data inputs of the device must be held at V<sub>CCI</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.
 DIR2, DIR1, and DIR(345) are referenced to V<sub>CCA</sub>.

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### ELECTRICAL CHARACTERISTICS<sup>(1)(2)</sup>

over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED		TEST CONDITIONS		N/	v	T <sub>A</sub> = 25°C			LINIT
PARAMETER		TEST CONDIT	ION2	V <sub>CCA</sub>	V <sub>CCB</sub>	MIN TYP <sup>(3)</sup> MAX			UNIT
		I <sub>OH</sub> = −100 μA		1.2 V to 3.6 V	1.2 V to 3.6 V	V <sub>CCO</sub> - 0.2			
	A port	1 4 4		1.2 V	1.2 V		1.1		
,		$I_{OH} = -1 \text{ mA}$		1.4 V	1.4 V	1.05			
/ <sub>ОН</sub>		$I_{OH} = -2 \text{ mA}$	$V_{I} = V_{IH}$	1.65 V	1.65 V	1.2			V
		I <sub>OH</sub> = -4 mA		2.3 V	2.3 V	1.75			
		I <sub>OH</sub> = -8 mA		3 V	3 V	2.3			
		I <sub>OL</sub> = 100 μA		1.2 V to 3.6 V	1.2 V to 3.6 V			0.2	
				1.2 V	1.2 V		0.07		
		$I_{OL} = 1 \text{ mA}$		1.4 V	1.4 V			0.35	.,
/ <sub>OL</sub>	A port	$I_{OL} = 2 \text{ mA}$ $V_{I}$	= V <sub>IL</sub>	1.65 V	1.65 V			0.45	V
		$I_{OL} = 4 \text{ mA}$		2.3 V	2.3 V			0.55	
		$I_{OL} = 8 \text{ mA}$		3 V	3 V			0.7	
		I <sub>OH</sub> = -100 μA		1.2 V to 3.6 V	1.2 V to 3.6 V	V <sub>CCO</sub> – 0.2			
		$I_{OH} = -1 \text{ mA}$		1.2 V	1.2 V	000	1.1		
		$l_{OH} = -2 \text{ mA}$		1.4 V	1.4 V	1.05			
/ <sub>ОН</sub>	B port	$I_{OH} = -4 \text{ mA}$ V <sub>I</sub>	V <sub>I</sub> = V <sub>IH</sub>	1.65 V	1.65 V	1.2			V
		$I_{OH} = -8 \text{ mA}$		2.3 V	2.3 V	1.75			
		$I_{OH} = -16 \text{ mA}$		3 V	3 V	2.3			
		$I_{OL} = 100 \mu A$		1.2 V to 3.6 V	1.2 V to 3.6 V	2.0		0.2	
V <sub>OL</sub>	B port	$I_{OL} = 1 \text{ mA}$	$V_{I} = V_{IL}$	1.2 V	1.2 V 10 0.0 V		0.07	0.2	V
		$I_{OL} = 2 \text{ mA}$		1.4 V	1.4 V		0.07	0.35	
		$I_{OL} = 4 \text{ mA}$ V <sub>I</sub>		1.65 V	1.65 V			0.45	
				2.3 V	2.3 V				
		$I_{OL} = 8 \text{ mA}$						0.55	
	Control	I <sub>OL</sub> = 16 mA		3 V	3 V			0.7	
I	Control inputs	$V_{I} = V_{CCA} \text{ or } GND$		1.2 V to 3.6 V	1.2 V to 3.6 V			±1	μA
off	A or B port	$V_{I}$ or $V_{O} = 0$ to 3.6 V		0 V	0 V to 3.6 V			±5	μA
UII	rei 2 per			0 V to 3.6 V	0 V			±5	μ.,
oz <sup>(4)</sup>	A or B port	$V_{O} = V_{CCO} \text{ or } GND, $ tak $V_{I} = V_{CCI} \text{ or } GND $ sta	ee function ble for input ates when itputs are Hi Z	3.6 V	3.6 V			±5	μA
				1.2 V to 3.6 V	1.2 V to 3.6 V			10	
CCA		$V_{I} = V_{CCI} \text{ or } GND, I_{O}$	= 0	3.6 V	0 V			10	μA
				0 V	3.6 V			-1	
				1.2 V to 3.6 V	1.2 V to 3.6 V			10	μA
ССВ		$V_{I} = V_{CCI}$ or GND, $I_{O}$	= 0	3.6 V	0 V			-1	
000				0 V	3.6 V			10	μη
CCA +	I <sub>CCB</sub>	$V_{I} = V_{CCI} \text{ or } GND, I_{O}$	= 0	1.2 V to 3.6 V	1.2 V to 3.6 V			15	μA
	Control						4 5		· ·
Ci	inputs	$V_I = V_{CCA}$ or GND		1.8 V	3 V		1.5	2	pF
	Clock input						2	2.5	
~	A port	$V_{O} = V_{CCA}$ or GND		1.9.\/	3 V		2.5	3	~~
C <sub>io</sub>	B port	$V_{O} = V_{CCB}$ or GND		1.8 V	SV		2.5	3	pF

 $\begin{array}{ll} (1) & V_{CCO} \text{ is the } V_{CC} \text{ associated with the output port.} \\ (2) & V_{CCI} \text{ is the } V_{CC} \text{ associated with the input port.} \\ (3) & \text{All typical values are at } T_A = 25^\circ\text{C}. \\ (4) & \text{For I/O ports, the parameter } I_{OZ} \text{ includes the input leakage current.} \\ \end{array}$ 

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### **OUTPUT SLEW RATES**<sup>(1)</sup>

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	FROM	то	V <sub>CCA</sub> = 1.8 V ± 0 V <sub>CCB</sub> = 3 V ± 0	UNIT	
			MIN	MAX	
t <sub>r</sub>	10%	90%		3 <sup>(2)</sup>	ns
t <sub>f</sub>	90%	10%		3 <sup>(2)</sup>	ns

(1) Values are characterized, but not production tested.

(2) Using  $C_L = 15 \text{ pF}$  on the B side and  $C_L = 7 \text{ pF}$  on the A side

### **TYPICAL SWITCHING CHARACTERISTICS**

 $T_A = 25^{\circ}C$ ,  $V_{CCA} = 1.2$  V (see Figure 2)

PARAMETER	FROM	TO	V <sub>CCB</sub> = 1.2 V	V <sub>CCB</sub> = 1.5 V	V <sub>CCB</sub> = 1.8 V	V <sub>CCB</sub> = 2.5 V	V <sub>CCB</sub> = 3 V	V <sub>CCB</sub> = 3.3 V	UNIT
	(INPUT)	(OUTPUT)	TYP	TYP	TYP	TYP	TYP	TYP	
	А	В	3.8	3	2.6	2.5	2.5	2.6	
	В	A	4.6	4.2	4	3.9	3.9	3.8	
t <sub>pd</sub>	A6	B6	3.8	3	2.6	2.5	2.5	2.6	ns
	A2	B2	3.8	3	2.6	2.5	2.5	2.6	
	B2	A2	4.6	4.2	4	3.9	3.9	3.8	
	DIR	В	4.8	4	3.7	3.4	3.4	3.4	
t <sub>en</sub> <sup>(1)</sup>	DIR	A	4.5	4.4	5	5.4	5.4	5.4	ns
t <sub>dis</sub> <sup>(1)</sup>		В	6.3	5.2	5.6	4.8	4.8	6.1	
<sup>L</sup> dis <sup>(1)</sup>	DIR	A	4.8	4.6	5.3	5.4	5.4	5.3	ns

(1) DIR refers to DIR2, DIR1, and DIR(345).

#### SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range,  $V_{CCA}$  = 1.5 V ± 0.1 V (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT	V <sub>CCB</sub> = 1.2 V	V <sub>CCB</sub> = ± 0.7	1.5 V 1 V	V <sub>CCB</sub> = ± 0.1		V <sub>CCB</sub> = ± 0.2		V <sub>ССВ</sub> : ± 0.3		V <sub>CCB</sub> = ± 0.3		UNIT
	(INFUT)	)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
	А	В	3.4	1.1	5.6	1	4.8	1	3.9	0.9	3.9	0.9	3.8	
	В	A	3.8	1.4	6	1.3	5.6	1.3	5.2	0.5	5.2	0.3	5.2	
t <sub>pd</sub>	A6	B6	3.4	1.1	5.6	1	4.8	1	3.9	0.9	3.9	0.9	3.8	ns
	A2	B2	3.4	1.1	5.6	1	4.8	1	3.9	0.9	3.9	0.9	3.8	
	B2	A2	3.8	1.4	6	1.3	5.6	1.3	5.2	0.5	5.2	0.3	5.2	
t <sub>en</sub> <sup>(1)</sup>	DIR	В	4	1.3	7.7	1.1	6.9	0.8	6.1	0.8	6	0.8	5.9	
Len (1)	DIR	А	3.5	1.4	7	1.5	7.4	1.7	8.2	1.7	8.2	1.7	7.7	ns
t <sub>dis</sub> <sup>(1)</sup>		В	5.7	1.9	8.9	2.1	10.4	1.8	8.7	1.7	8.5	2.4	11.4	
<sup>L</sup> dis <sup>(1)</sup>	DIR	А	3.4	1.2	7	1.2	6.8	1.2	6.9	1.2	6.5	1.2	6.6	ns

(1) DIR refers to DIR2, DIR1, and DIR(345).



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#### SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range,  $V_{CCA} = 1.8 \text{ V} \pm 0.15 \text{ V}$  (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CCB</sub> = 1.2 V	V <sub>CCB</sub> = ± 0.		V <sub>CCB</sub> = ± 0.1		V <sub>CCB</sub> = ± 0.2		V <sub>ССВ</sub> = ± 0.3		V <sub>CCB</sub> = ± 0.		UNIT
	(INFUT)	(001201)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
	А	В	3.2	1	5.2	0.8	4.4	0.7	3.5	0.6	3.4	0.7	3.1	
	В	А	3.4	1.1	5.2	1	4.8	0.9	4.3	0.3	4.3	0.2	4.3	
t <sub>pd</sub>	A6	B6	3.2	1	5.2	0.8	4.4	0.7	3.5	0.6	3.4	0.7	3.1	ns
	A2	B2	3.2	1	5.2	0.8	4.4	0.7	3.5	0.6	3.4	0.7	3.1	
	B2	A2	3.4	1.1	5.2	1	4.8	0.9	4.3	0.3	4.3	0.2	4.3	
t <sub>en</sub> <sup>(1)</sup>	DIR	В	3.5	1.2	6.8	0.9	6	0.7	5.1	0.7	5	0.7	4.8	20
len` ′	DIK	А	2.9	1.1	4.7	1.1	5.2	1.4	5.1	1.4	5.1	1.4	5.3	ns
t <sub>dis</sub> <sup>(1)</sup>	DIR	В	5.3	1.6	8.4	2	9.5	1.6	8.2	1.4	8.1	2.2	8.2	20
<sup>L</sup> dis <sup>(1)</sup>	DIR	А	3.6	1.3	7.7	1.2	7.9	1.3	7.5	1.3	7.5	1.3	7.6	ns

(1) DIR refers to DIR2, DIR1, and DIR(345).

#### SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range,  $V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$  (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CCB</sub> = 1.2 V	V <sub>CCB</sub> = ± 0.1		V <sub>CCB</sub> = ± 0.1		V <sub>CCB</sub> = ± 0.2		V <sub>CCB</sub> : ± 0.3		V <sub>CCB</sub> = ± 0.3		UNIT
	(INPUT)	(001201)	TYP	MIN	MAX									
	А	В	3	0.8	4.7	0.7	3.8	0.6	2.9	0.4	2.7	0.5	2.5	
	В	А	3	0.9	4.4	0.7	3.9	0.6	3.3	0.3	3.2	0.3	3.2	
t <sub>pd</sub>	A6	B6	3	0.8	4.7	0.7	3.8	0.6	2.9	0.4	2.7	0.5	2.5	ns
	A2	B2	3	0.8	4.7	0.7	3.8	0.6	2.9	0.4	2.7	0.5	2.5	
	B2	A2	3	0.9	4.4	0.7	3.9	0.6	3.3	0.3	3.2	0.3	3.2	
t <sub>en</sub> (1)	DIR	В	3.1	1	5.7	0.8	4.8	0.5	3.9	0.5	3.7	0.5	3.6	20
<sup>L</sup> en`′	DIR	А	2.2	0.7	3.5	0.6	4.3	1.2	4.4	0.7	4.6	0.4	4.7	ns
+	DIR	В	4.6	1.4	7.6	1.8	8.4	1.3	7.2	1.3	7.1	2	7.5	20
t <sub>dis</sub>	אוט	А	2.6	0.9	5.6	0.9	5.4	1	5.5	0.9	5.5	0.9	5.8	ns

(1) DIR refers to DIR2, DIR1, and DIR(345).



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#### SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range,  $V_{CCA} = 3.3 \text{ V} \pm 0.3 \text{ V}$  (see Figure 2)

PARAMETER		TO	V <sub>CCB</sub> = 1.2 V	V <sub>CCB</sub> = ± 0.7		V <sub>CCB</sub> = ± 0.1		V <sub>CCB</sub> = ± 0.2		V <sub>ССВ</sub> : ± 0.3		V <sub>CCB</sub> = ± 0.3		UNIT
	(INPUT)	(OUTPUT)	TYP	MIN	MAX									
	А	В	2.8	0.8	4.5	0.6	3.6	0.4	2.7	0.4	2.7	0.3	2.3	
	В	A	2.9	0.8	4.3	0.6	3.7	0.5	3	0.5	3	0.1	2.7	
t <sub>pd</sub>	A6	B6	2.8	0.8	4.5	0.6	3.6	0.4	2.7	0.4	2.7	0.3	2.3	ns
	A2	B2	2.8	0.8	4.5	0.6	3.6	0.4	2.7	0.4	2.7	0.3	2.3	
	B2	A2	2.9	0.8	4.3	0.6	3.7	0.5	3	0.5	3	0.1	2.7	
t <sub>en</sub> (1)	DIR	В	3	1	5.1	0.6	4.3	0.5	3.4	0.5	3.4	0.4	3	
<sup>l</sup> en`′	DIR	А	2	0.6	3.1	0.6	5.4	0.7	5.4	0.7	5.4	0.5	5.4	ns
t <sub>dis</sub> (1)	DIR	В	4.4	1.4	7.4	1.8	8.3	1.2	7	1.2	7	2	7.3	
<sup>L</sup> dis <sup>C</sup>	UIK	А	3.7	1.5	8.1	1.5	7.9	1.5	7.9	1.5	7.9	1.5	8	ns

(1) DIR refers to DIR2, DIR1, and DIR(345).

### TYPICAL FREQUENCY AND OUTPUT SKEW

 $T_A = 25^{\circ}C$ ,  $V_{CCA} = 1.2$  V (see Figure 2)

DAD	AMETER	FROM	то	$V_{CCB}$ = 1.2 V	V <sub>CCB</sub> = 1.5 V	V <sub>CCB</sub> = 1.8 V	$V_{CCB}$ = 2.5 V	$V_{CCB} = 3 V$	V <sub>CCB</sub> = 3.3 V	UNIT
FAR/		(INPUT)	(OUTPUT)	TYP	TYP	TYP	TYP	TYP	TYP	UNIT
	Clock	A6	B6	95	95	95	95	95	95	
t <sub>max</sub>	Data	А	В	95	95	95	95	95	95	MHz
	Dala	В	А	95	95	95	95	95	95	
t <sub>sk(o)</sub>	Channel- to- channel	А	В	0.5	0.4	0.4	0.3	0.5	0.5	ns

### MAXIMUM FREQUENCY AND OUTPUT SKEW

over recommended operating free-air temperature range,  $V_{CCA} = 1.5 \text{ V} \pm 0.1 \text{ V}$  (see Figure 2)

PAF	RAMETER	FROM (INPUT)		V <sub>CCB</sub> = 1.2 V	V <sub>CCB</sub> = ± 0.1		V <sub>CCB</sub> = ± 0.1		V <sub>CCB</sub> = ± 0.2		V <sub>ССВ</sub> ± 0.	= 3 V 3 V	V <sub>ССВ</sub> = ± 0.		UNIT
		(INFUT)	(OUTPUT)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
	Clock	A6	B6	95	95		95		95		95		95		
f <sub>max</sub>	Dete	Α	В	95	95		95		95		95		95		MHz
	Data	В	А	95	95		95		95		95		95		
t <sub>sk(o)</sub>	Channel- to- channel	DIR	В	0.3		0.3		0.3		0.3		0.5		0.4	ns

### MAXIMUM FREQUENCY AND OUTPUT SKEW

over recommended operating free-air temperature range,  $V_{CCA} = 1.8 \text{ V} \pm 0.15 \text{ V}$  (see Figure 2)

PAF	RAMETER	FROM (INPUT)		V <sub>CCB</sub> = 1.2 V	V <sub>CCB</sub> = ± 0.1	1.5 V I V	V <sub>ССВ</sub> = ± 0.1		V <sub>CCB</sub> = ± 0.2		V <sub>ССВ</sub> ± 0.		V <sub>CCB</sub> = ± 0.		UNIT
		(INFUT)	(OUTPUT)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
	Clock	A6	B6	95	95		95		95		95		95		
f <sub>max</sub>	Data	Α	В	95	95		95		95		95		95		MHz
	Data	В	А	95	95		95		95		95		95		
t <sub>sk(o)</sub>	Channel- to- channel	DIR	В	0.3		0.3		0.3		0.3		0.5		0.3	ns

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SCES706A-SEPTEMBER 2008-REVISED MARCH 2009

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### MAXIMUM FREQUENCY AND OUTPUT SKEW

over recommended operating free-air temperature range, V<sub>CCA</sub> = 2.5 V  $\pm$  0.2 V (see Figure 2)

PAF	RAMETER			V <sub>CCB</sub> = 1.2 V	V <sub>CCB</sub> = ± 0.1		V <sub>ССВ</sub> = ± 0.1		V <sub>CCB</sub> = ± 0.2		V <sub>CCB</sub> ± 0.		V <sub>CCB</sub> = ± 0.		UNIT
		(INPUT)	(OUTPUT)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
	Clock	A6	B6	95	95		95		95		95		95		
f <sub>max</sub>	Data	А	В	95	95		95		95		95		95		MHz
	Dala	В	А	95	95		95		95		95		95		
t <sub>sk(o)</sub>	Channel- to- channel	DIR	В	0.3		0.3		0.3		0.2		0.6		0.3	ns

### MAXIMUM FREQUENCY AND OUTPUT SKEW

over recommended operating free-air temperature range,  $V_{CCA} = 3.3 \text{ V} \pm 0.3 \text{ V}$  (see Figure 2)

PAF	RAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CCB</sub> = 1.2 V	V <sub>CCB</sub> = ± 0.1		V <sub>ССВ</sub> = ± 0.1		V <sub>CCB</sub> = ± 0.2		V <sub>ССВ</sub> ± 0.	= 3 V 3 V	V <sub>CCB</sub> = ± 0.		UNIT
		(INFUT)	(001F01)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
	Clock	A6	B6	95	95		95		95		95		95		
f <sub>max</sub>	Data	А	В	95	95		95		95		95		95		MHz
	Dala	В	А	95	95		95		95		95		95		
t <sub>sk(o)</sub>	Channel- to- channel	DIR	В	0.3		0.3		0.4		0.3		0.6		0.4	ns

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### **OPERATING CHARACTERISTICS**

 $T_A = 25^{\circ}C$ 

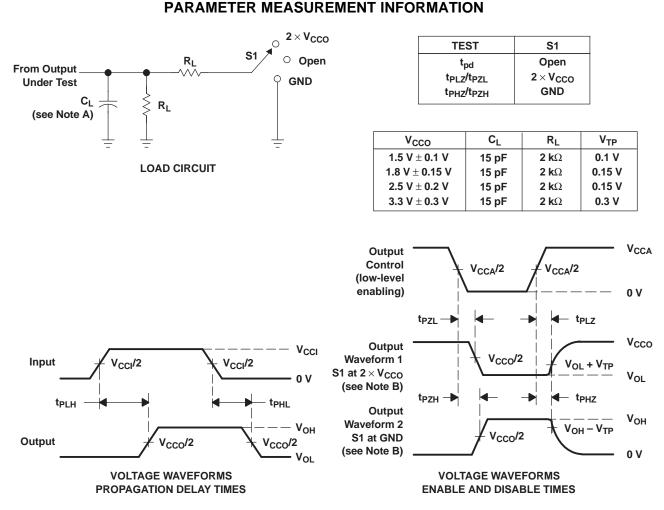
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PARA	METER	TEST CONDITIONS	V <sub>CCA</sub> = V <sub>CCB</sub> = 1.2 V TYP	V <sub>CCA</sub> = V <sub>CCB</sub> = 1.5 V TYP	V <sub>CCA</sub> = V <sub>CCB</sub> = 1.8 V TYP	V <sub>CCA</sub> = V <sub>CCB</sub> = 2.5 V TYP	V <sub>CCA</sub> = V <sub>CCB</sub> = 3 V TYP	V <sub>CCA</sub> = V <sub>CCB</sub> = 3.3 V TYP	UNIT
<b>O</b> (1)	A-port input, B-port output	$C_{L} = 0,$	1.9	2	2.1	2.4	2.7	2.9	. 6
C <sub>pdA</sub> <sup>(1)</sup>	B-port input, A-port output	f = 10 MHz, t <sub>r</sub> = t <sub>f</sub> = 1 ns	4.4	4.5	4.6	4.7	4.8	4.9	рF
<b>C</b> (1)	A-port input, B-port output	C <sub>L</sub> = 0, f = 10 MHz,	5.3	5.4	5.4	5.7	5.8	5.9	~ 5
C <sub>pdB</sub> <sup>(1)</sup>	B-port input, A-port output	$t_r = t_f = 1 \text{ ns}$	0.3	0.3	0.4	0.5	0.6	0.6	рF

(1) Power dissipation capacitance per transceiver

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- NOTES: A. CL includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
     C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z<sub>O</sub> = 50 Ω, dv/dt ≥ 1 V/ns.
  - C. An input purses are supplied by generators having the following characteristics: PKK ≤ 10 MHz,  $z_0$  = 50 Ω, dV/dt ≥ 1.
  - D. The outputs are measured one at a time, with one transition per measurement.
  - E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
  - H.  $V_{CCI}$  is the  $V_{CC}$  associated with the input port.
  - I.  $V_{CCO}$  is the  $V_{CC}$  associated with the output port.

### Figure 2. Load Circuit and Voltage Waveforms



6-Feb-2020

### PACKAGING INFORMATION

Orderable Device	Status	Package Type	•	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
SN74AVC6T622PWR	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 85	WU622	Samples
SN74AVC6T622RGYR	ACTIVE	VQFN	RGY	20	3000	Green (RoHS & no Sb/Br)	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	WU622	Samples
SN74AVC6T622ZXYR	LIFEBUY	BGA MICROSTAR JUNIOR	ZXY	20	2500	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 85	WU622	

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <= 1000ppm threshold. Antimony trioxide based flame retardants must also meet the <= 1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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# **PACKAGE MATERIALS INFORMATION**

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### **TAPE AND REEL INFORMATION**





### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74AVC6T622PWR	TSSOP	PW	20	2000	330.0	16.4	6.95	7.1	1.6	8.0	16.0	Q1
SN74AVC6T622RGYR	VQFN	RGY	20	3000	330.0	12.4	3.8	4.8	1.6	8.0	12.0	Q1
SN74AVC6T622ZXYR	BGA MI CROSTA R JUNI OR	ZXY	20	2500	330.0	12.4	2.75	3.45	1.05	4.0	12.0	Q2

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## PACKAGE MATERIALS INFORMATION

16-Oct-2020



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74AVC6T622PWR	TSSOP	PW	20	2000	367.0	367.0	38.0
SN74AVC6T622RGYR	VQFN	RGY	20	3000	853.0	449.0	35.0
SN74AVC6T622ZXYR	BGA MICROSTAR JUNIOR	ZXY	20	2500	350.0	350.0	43.0

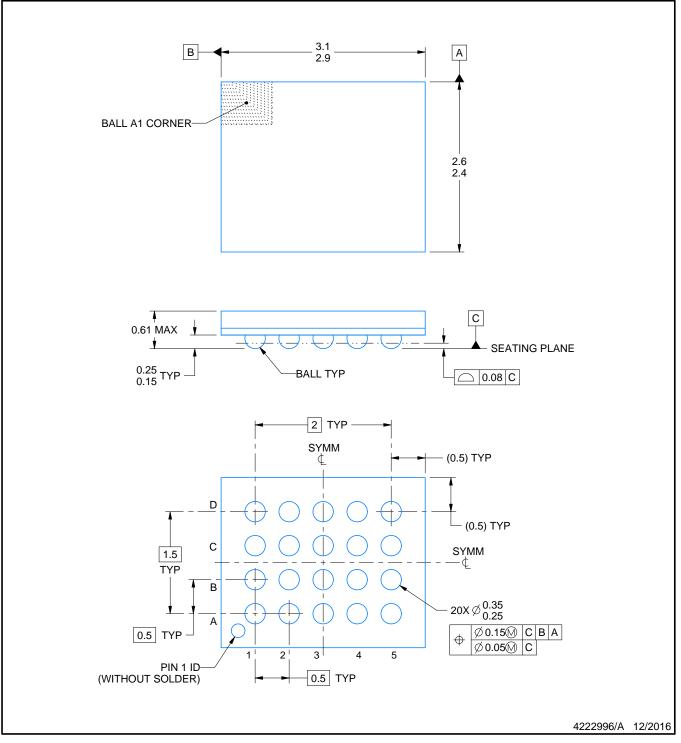
# **ZXY0020A**



# **PACKAGE OUTLINE**

## VFBGA - 0.61 mm max height

PLASTIC BALL GRID ARRAY



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.2. This drawing is subject to change without notice.

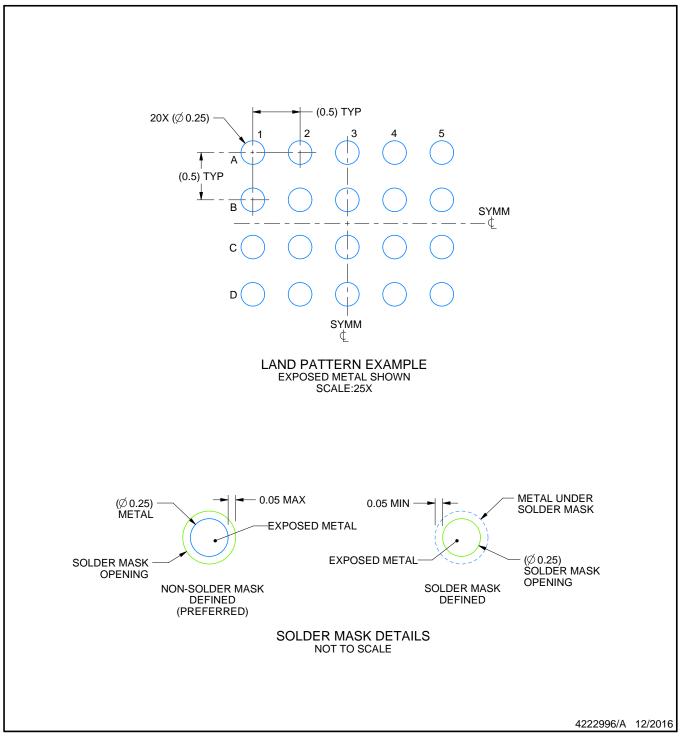


# ZXY0020A

# **EXAMPLE BOARD LAYOUT**

## VFBGA - 0.61 mm max height

PLASTIC BALL GRID ARRAY



NOTES: (continued)

3. Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. For information, see Texas Instruments literature number SPRAA99 (www.ti.com/lit/spraa99).

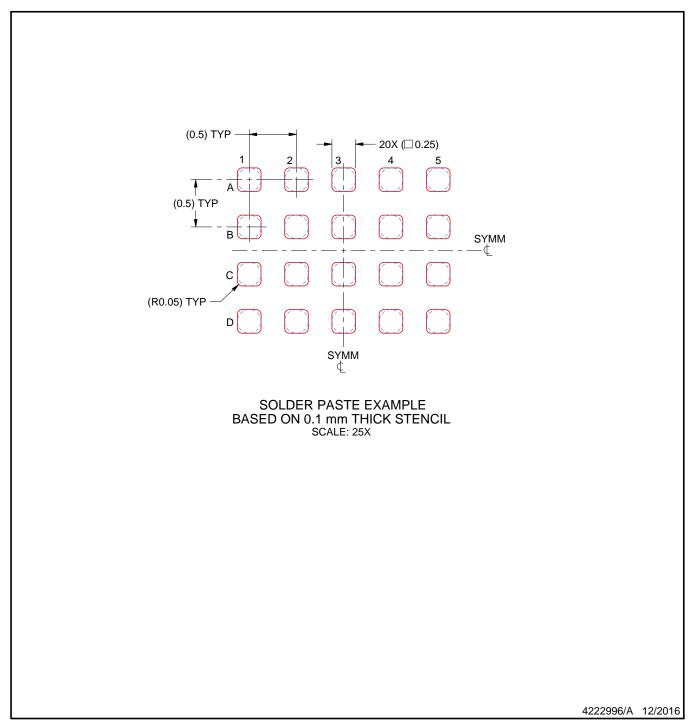


# ZXY0020A

# **EXAMPLE STENCIL DESIGN**

## VFBGA - 0.61 mm max height

PLASTIC BALL GRID ARRAY



NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.



PW (R-PDSO-G20)

PLASTIC SMALL OUTLINE



NOTES:

A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.  $\beta$ . This drawing is subject to change without notice.

Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.

Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.

E. Falls within JEDEC MO-153



## LAND PATTERN DATA



NOTES: Α. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
  C. Publication IPC-7351 is recommended for alternate design.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



## **GENERIC PACKAGE VIEW**

## VQFN - 1 mm max height

PLASTIC QUAD FGLATPACK - NO LEAD

3.5 x 4.5, 0.5 mm pitch

**RGY 20** 

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.





4225264/A

# **RGY0020A**



# **PACKAGE OUTLINE**

### VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



#### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice.
- 3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.



# **RGY0020A**

# **EXAMPLE BOARD LAYOUT**

## VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).

5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.



# **RGY0020A**

# **EXAMPLE STENCIL DESIGN**

## VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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